| | | | | | |
|---|---|---|---|---|---|
| E | 2016-3 | | | | |
| F | 2018-12-14 | 2 | t | | |

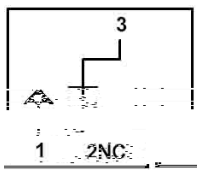
## / Descriptions

SOT-23

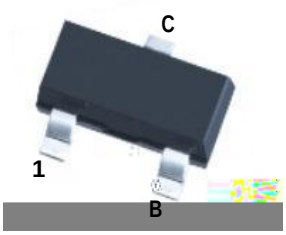
## / Features

## / Applications

## / Equivalent Circuit



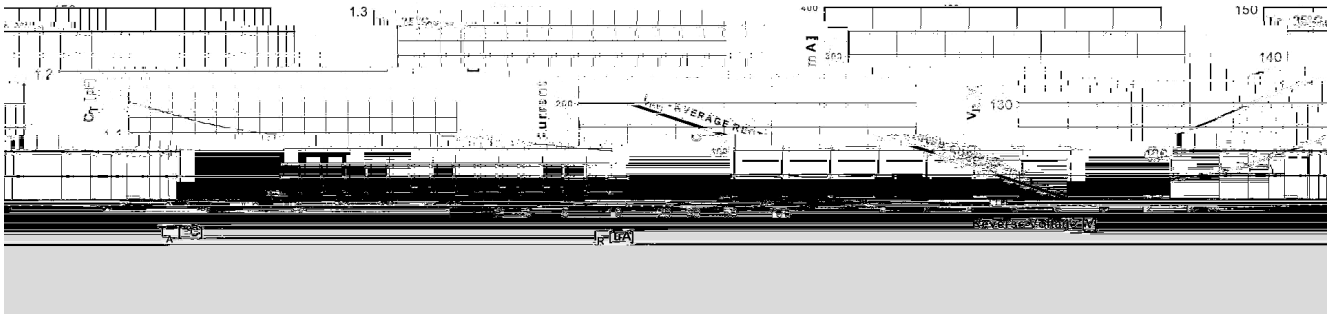

## / Pinning

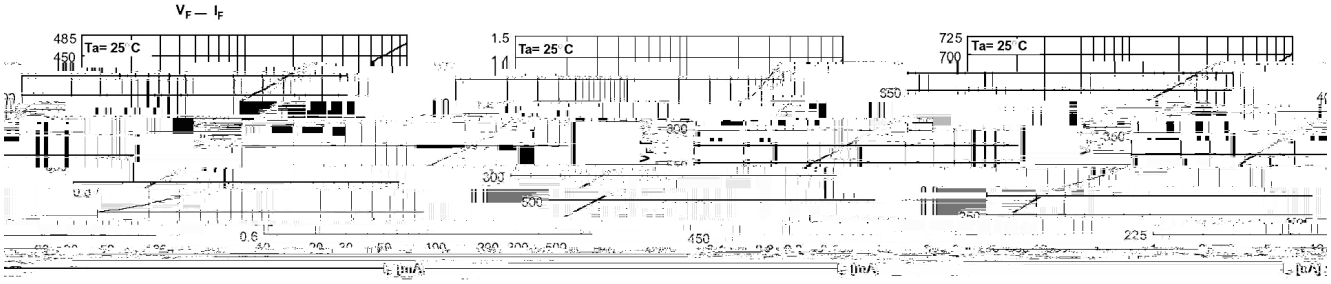


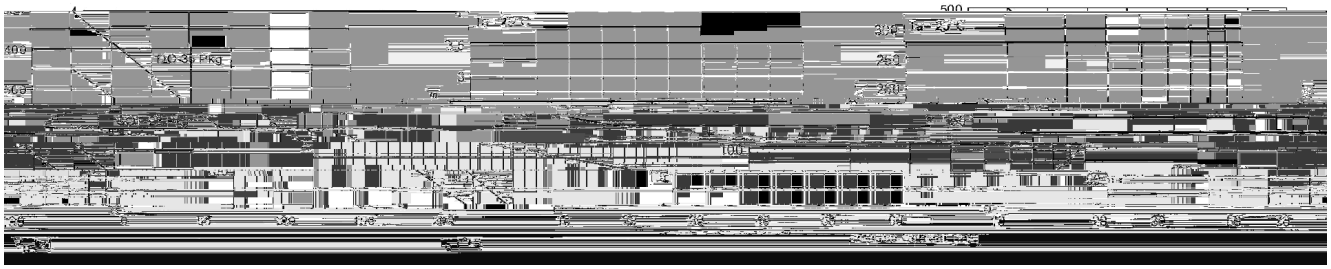

## / $h_{FE}$ Classifications & Marking

| | |
|---|---|

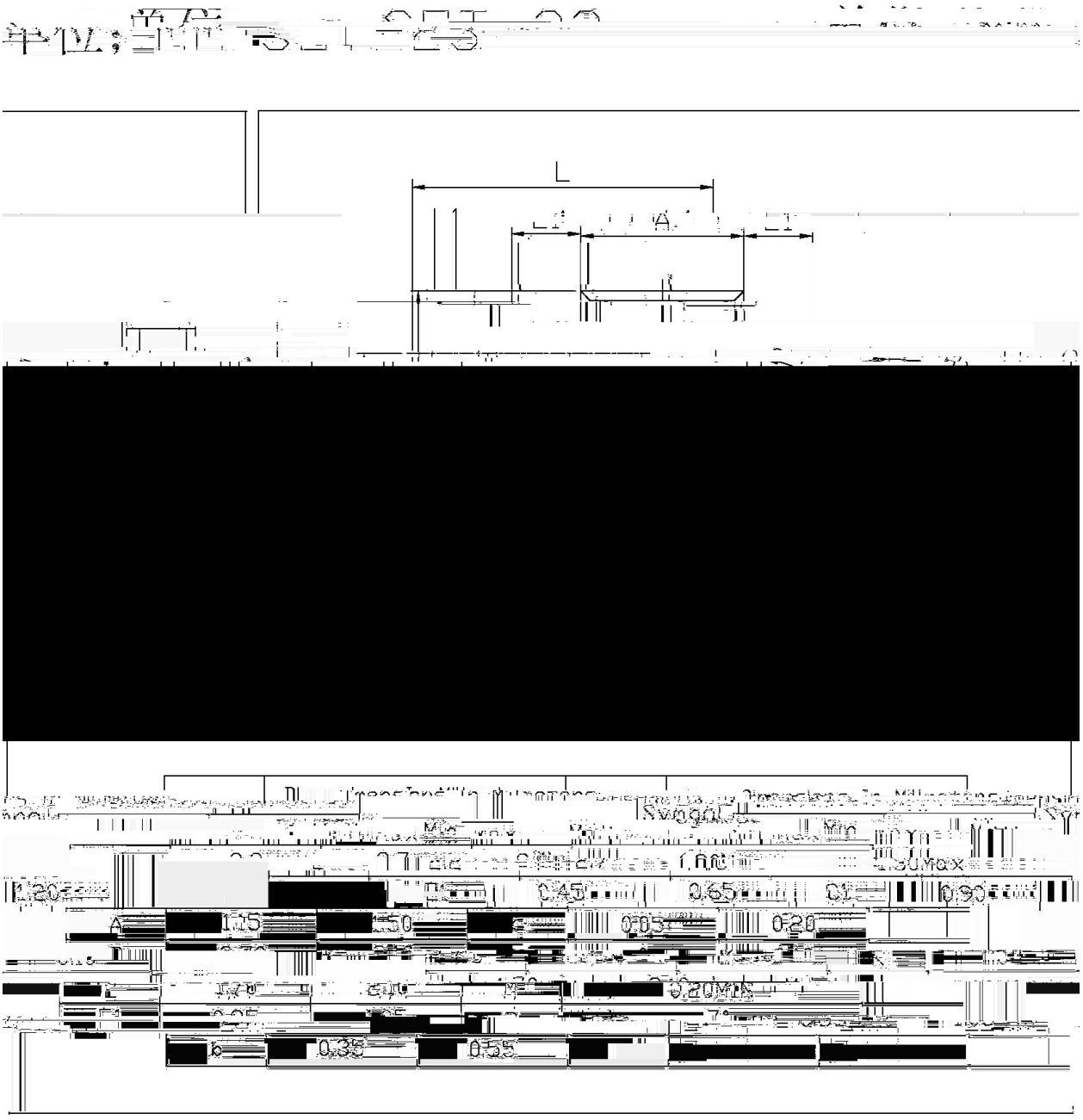
## / Electrical Characteristic Curve

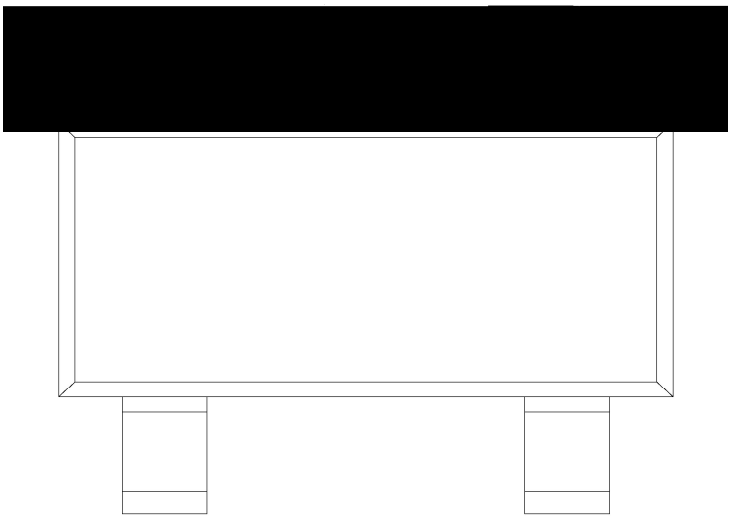




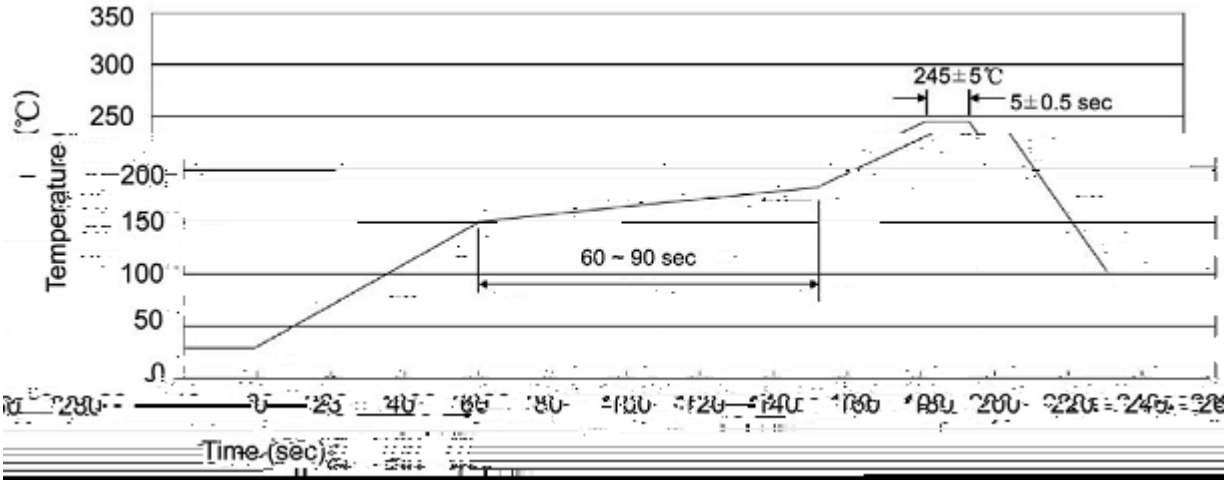



## / Package Dimensions





## ( ) / Temperature Profile for IR Reflow Soldering(Pb-Free)




± ± ± ±

## / Resistance to Soldering Heat Test Conditions

± ± ℃

## / Packaging SPEC.

| ! | " # $ | | | | | " % & ' | | |
|---|---|---|---|---|---|---|---|---|
| | Units/Reel 只/卷盘 | Reels/Inner Box 卷盘/盒 | Units/Inner Box 只/盒 | Inner Boxes/Outer Box 盒/箱 | Units/Outer Box 只/箱 | Reel | Inner Box ( | Outer Box ) |
| SOT-23 | 3,000 | 10 | 30,000 | 8 | 240,000 | 7″ ×8 | 180×120×180 | 385×257×392 |

## / Notices